

ISO/IEC JTC1/SC17 STANDING DOCUMENT 5
(Updated March 2018)

Register of IC manufacturers

Identifier	Company	Country
'01'	Motorola	UK
'02'	STMicroelectronics SA	France
'03'	Hitachi, Ltd	Japan
'04'	NXP Semiconductors	Germany
'05'	Infineon Technologies AG	Germany
'06'	Cylink	USA
'07'	Texas Instrument	France
'08'	Fujitsu Limited	Japan
'09'	Matsushita Electronics Corporation, Semiconductor Company	Japan
'0A'	NEC	Japan
'0B'	Oki Electric Industry Co. Ltd	Japan
'0C'	Toshiba Corp.	Japan
'0D'	Mitsubishi Electric Corp.	Japan
'0E'	Samsung Electronics Co. Ltd	Korea
'0F'	Hynix	Korea
'10'	LG-Semiconductors Co. Ltd	Korea
'11'	Emosyn-EM Microelectronics	USA
'12'	INSIDE Technology	France
'13'	ORGA Kartensysteme GmbH	Germany
'14'	SHARP Corporation	Japan
'15'	ATMEL	France
'16'	EM Microelectronic-Marin SA	Switzerland
'17'	SMARTRAC TECHNOLOGY GmbH	Germany
'18'	ZMD AG	Germany
'19'	XICOR, Inc.	USA
'1A'	Sony Corporation	Japan

Identifier	Company	Country
'1B'	Malaysia Microelectronic Solutions Sdn. Bhd	Malaysia
'1C'	Emosyn	USA
'1D'	Shanghai Fudan Microelectronics Co. Ltd.	P.R. China
'1E'	Magellan Technology Pty Limited	Australia
'1F'	Melexis NV BO	Switzerland
'20'	Renesas Technology Corp.	Japan
'21'	TAGSYS	France
'22'	Transcore	USA
'23'	Shanghai belling corp., ltd.	China
'24'	Masktech Germany Gmbh	Germany
'25'	Innovision Research and Technology Plc	UK
'26'	Hitachi ULSI Systems Co., Ltd.	Japan
'27'	Yubico AB	Sweden
'28'	Ricoh	Japan
'29'	ASK	France
'2A'	Unicore Microsystems, LLC	Russian Federation
'2B'	Dallas Semiconductor/Maxim	USA
'2C'	Impinj, Inc.	USA
'2D'	RightPlug Alliance	USA
'2E'	Broadcom Corporation	USA
'2F'	MStar Semiconductor, Inc	Taiwan, ROC
'30'	BeeDar Technology Inc.	USA
'31'	RFIDsec	Denmark
'32'	Schweizer Electronic AG	Germany
'33'	AMIC Technology Corp	Taiwan
'34'	Mikron JSC	Russia
'35'	Fraunhofer Institute for Photonic Microsystems	Germany
'36'	IDS Microchip AG	Switzerland
'37'	Kovio	USA
'38'	HMT Microelectronic Ltd	Switzerland
'39'	Silicon Craft Technology	Thailand

Identifier	Company	Country
'3A'	Advanced Film Device Inc.	Japan
'3B'	Nitecrest Ltd	UK
'3C'	Verayo Inc.	USA
'3D'	HID Global	USA
'3E'	Productivity Engineering Gmbh	Germany
'3F'	Austriamicrosystems AG (reserved)	Austria
'40'	Gemalto SA	France
'41'	Renesas Electronics Corporation	Japan
'42'	3Alogics Inc	Korea
'43'	Top TroniQ Asia Limited	Hong Kong
'44'	Gentag Inc (USA)	USA
'45'	Invengo Information Technology Co.Ltd	China
'46'	Guangzhou Sysur Microelectronics, Inc	China
'47'	CEITEC S.A.	Brazil
'48'	Shanghai Quanray Electronics Co. Ltd.	China
'49'	MediaTek Inc	Taiwan
'4A'	Angstrom PJSC	Russia
'4B'	Celisic Semiconductor (Hong Kong) Limited	China
'4C'	LEGIC Identsystems AG	Switzerland
'4D'	Balluff GmbH	Germany
'4E'	Oberthur Technologies	France
'4F'	Silterra Malaysia Sdn. Bhd.	Malaysia
'50'	DELTA Danish Electronics, Light & Acoustics	Denmark
'51'	Giesecke & Devrient GmbH	Germany
'52'	Shenzhen China Vision Microelectronics Co., Ltd.	China
'53'	Shanghai Feiju Microelectronics Co. Ltd.	China
'54'	Intel Corporation	USA
'55'	Microsensus GmbH	Germany
'56'	Sonix Technology Co., Ltd.	Taiwan
'57'	Qualcomm Technologies Inc	USA
'58'	Realtek Semiconductor Corp	Taiwan

Identifier	Company	Country
'59'	Freevision Technologies Co. Ltd	China
'5A'	Giantec Semiconductor Inc.	China
'5B'	JSC Angstrom-T	Russia
'5C'	STARCHIP	France
'5D'	SPIRTECH	France
'5E'	GANTNER Electronic GmbH	Austria
'5F'	Nordic Semiconductor	Norway
'60'	Verisiti Inc	USA
'61'	Wearlinks Technology Inc.	China
'62'	Userstar Information Systems Co., Ltd	Taiwan
'63'	Pragmatic Printing Ltd.	UK
'64'	Associação do Laboratório de Sistemas Integráveis Tecnológico – LSI-TEC	Brazil
'65"	Tendyron Corporation	China
'66'	MUTO Smart Co., Ltd.	Korea
'67'	ON Semiconductor	USA
'68'	TÜBİTAK BİLGEM	Turkey
'69'	Huada Semiconductor Co., Ltd	China
'6A'	SEVENEY	France
'6B'	ISSM	France
'6C'	Wisecsec Ltd	Israel
'7E'	Holtek	Taiwan